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2-330808-8 Product Details



2-330808-8

TE Internal Number: 2-330808-8



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Discrete Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- Mini-Spring Socket Product Line
- Board-to-Board, Wire-to-Board
- Applies To Wire/Cable, Applies To Printed Circuit Board
- Contact Rated Current = 5 A Wire/Cable Size = .081 .162 mm²

View all Features

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Documentation & Additional Information

Product Drawings:

MINIATURE SPRING SOCKET ASSEMBLY (PDF, English)

Catalog Pages/Data Sheets:

• None Available

Product Specifications:

None Available

Application Specifications:

Miniature Spring Socket Contacts (PDF, English)

Instruction Sheets:

• None Available

CAD Files: (CAD Format & Compression Information)

- 2D Drawing (DXF, Version CB2) • 3D Model (IGES, Version CB2)
- 3D Model (STEP, Version CB2)

Additional Information:

Product Line Information

Related Products:

Tooling

List all Documents

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Product Line = Mini-Spring Socket
- Sleeve Style = Closed Bottom
- Sealant = Without
- Wire/Cable Type = Discrete Wire
- Product Series = 3
- Profile = Zero

Electrical Characteristics:

• Contact - Rated Current (A) = 5

Termination Features:

- Wire/Cable Size (mm²) = 0.081 0.162
- Wire/Cable Size (AWG) = 25 28
- Insertion Method = Hand/Semi-Automatic
- Termination Method to Wire/Cable = Solder
- Termination Method to PC Board = Through Hole -Press Fit

- Contact Spring Plating = Gold (30)
- Contact Plating, Mating Area, Material = Gold (30)
- Contact Plating, Mating Area, Thickness (µm [µin]) = 0.00076 [0.03]
- Contact Type = Socket
- Contact Base Material = Beryllium Copper

Industry Standards:

- Government/Industry Qualification = No
- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Wave solder capable to 260°C, Wave solder capable to 240°C, Wave solder capable to 265°C, Reflow solder capable to

245°C, Reflow solder capable to 260°C, Pin-in-Paste capable to 245°C, Pin-in-Paste capable to 260°C

RoHS/ELV Compliance History = Always was RoHS

Dimensions:

- Socket Length (mm [in]) = 3.61 [0.142]
- Recommended Hole Size (mm [in]) = 1.04 [0.041]
- PCB Thickness, Recommended (mm [in]) = 0.79 -3.18 [0.031 - 0.125]

Body Features:

- Mating Pin Dia. Range (mm [in]) = 0.33 0.51 [0.013 - 0.020]
- Sleeve Material Plating = Gold Flash over Nickel
- Wire Type = Solid
- Sleeve Material = Copper
- Spring Material = Beryllium Copper

compliant

Environmental:

• Operating Temperature (°C [°F]) = -65 - +126 [-85 - +258]

Operation/Application:

- Application Use = Board-to-Board, Wire-to-Board
- Contact Transmits (Typical Application) = Signal (Data)/Power
- Application = Production

Packaging Features:

- Packaging Method = Loose Piece
- Packaging Quantity = 2,000/Bag

Other:

• Brand = AMP

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